

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
-20V	27m Ω @-10V	-5.6A
	36m Ω @-2.5V	

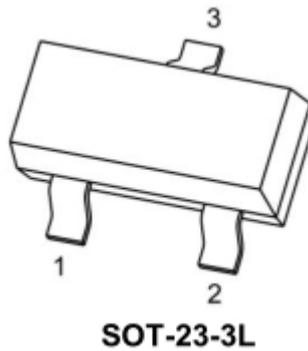
Feature

- TrenchFET Power MOSFET
- Excellent RDS(on) and Low Gate Charge
- ESD Protected:2KV

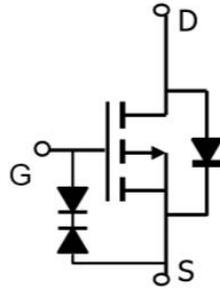
Applications

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Switch

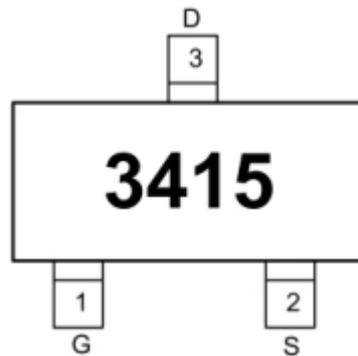
Package



Circuit diagram



Marking



Absolute maximum ratings

($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current	I_D	-5.6	A
Maximum Pulsed Drain to Source Diode Forward Current	I_{DM}	-23	A
Power Dissipation	P_D	1.3	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	96	$^{\circ}\text{C}/\text{W}$
Junction Temperature	T_J	150	
Storage Temperature	T_{STG}	-55~ +150	$^{\circ}\text{C}$

Electrical characteristics

($T_A=25^{\circ}\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	BV (BR) _{DSS}	$V_{GS} = 0\text{V}, I_D = -250\mu\text{A}$	-30			V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = -20\text{V}, V_{GS} = 0\text{V}$			-1	μA
Gate-body leakage current	I_{GSS}	$V_{GS} = \pm 10\text{V}, V_{DS} = 0\text{V}$			± 5	μA
Gate threshold voltage ¹⁾	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-0.45	-0.6	-0.85	V
Drain-source on-resistance ¹⁾	$R_{DS(on)}$	$V_{GS} = -4.5\text{V}, I_D = -5.6\text{A}$		27	34	m Ω
		$V_{GS} = -2.5\text{V}, I_D = -4.3\text{A}$		36	48	
Dynamic Characteristics²⁾						
Input capacitance	C_{iss}	$V_{DS} = -10\text{V}, V_{GS} = 0\text{V},$ $f = 1\text{MHz}$		940		pF
Output capacitance	C_{oss}			219		
Reverse transfer capacitance	C_{rss}			116		
Switching Characteristics						
Total Gate Charge	Q_g	$V_{GS} = -4.5\text{V}, V_{DD} = -10\text{V},$ $I_D = -4\text{A}$		7.2		nC
Gate Source Charge	Q_{gs}			1.2		
Gate Drain Charge	Q_{gd}			1.6		
Turn-on Delay Time	$T_{d(on)}$	$V_{GS} = -4.5\text{V}, V_{DS} = -10\text{V},$ $R_L = 2.5\Omega, R_{GEN} = 3\Omega$		12		nS
Turn-on Rise Time	T_r			10		
Turn-Off Delay Time	$T_{d(off)}$			19		
Turn-Off Fall Time	t_f			25		
Source-Drain Diode Characteristics						
Diode Forward voltage	V_{DS}	$I_S = -4\text{A}, V_{GS} = 0\text{V}$			-1.2	V

Notes:

1. Repetitive Rating : Pulse width limited by maximum junction temperature.
2. Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.

Typical Characteristics

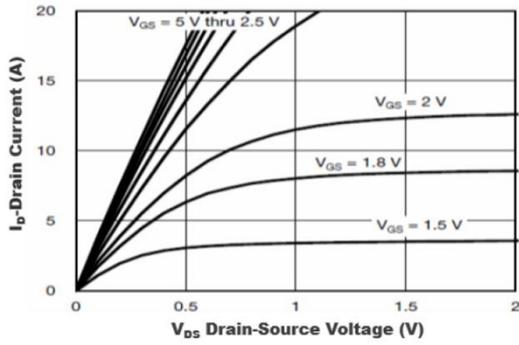


Figure1. Output Characteristics

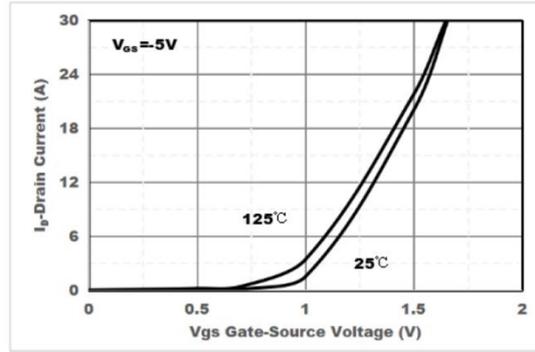


Figure2. Transfer Characteristics

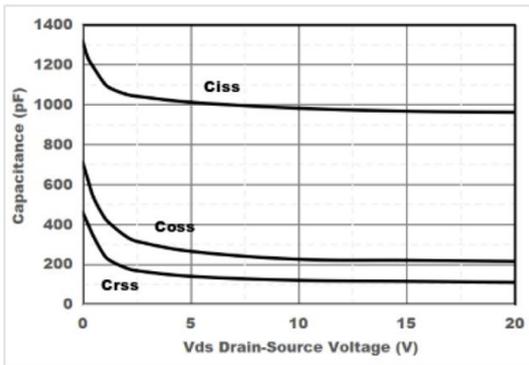


Figure3. Capacitance Characteristics

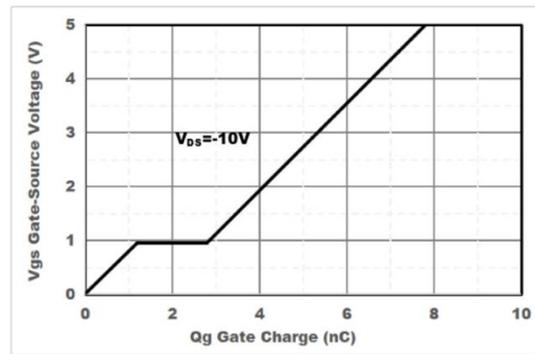


Figure4. Gate Charge

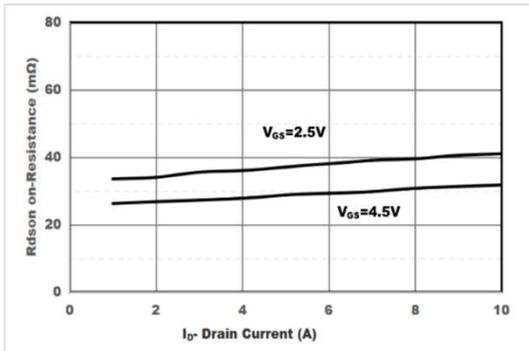


Figure5. Drain-Source on Resistance

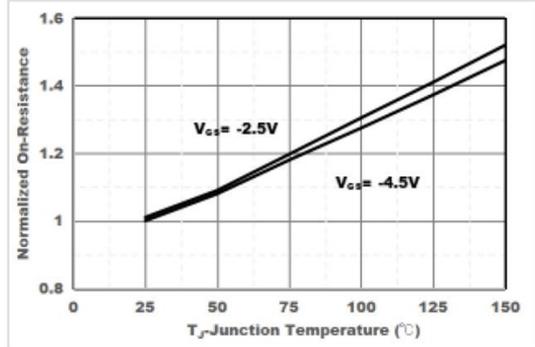


Figure6. Drain-Source on Resistance

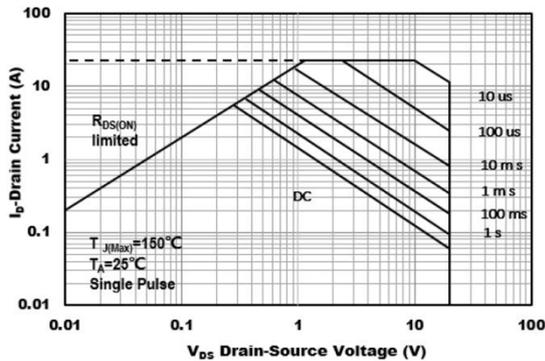


Figure7. Safe Operation Area

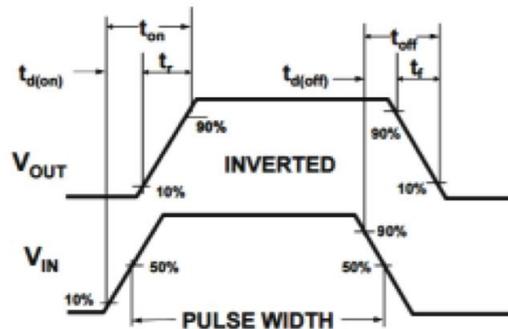
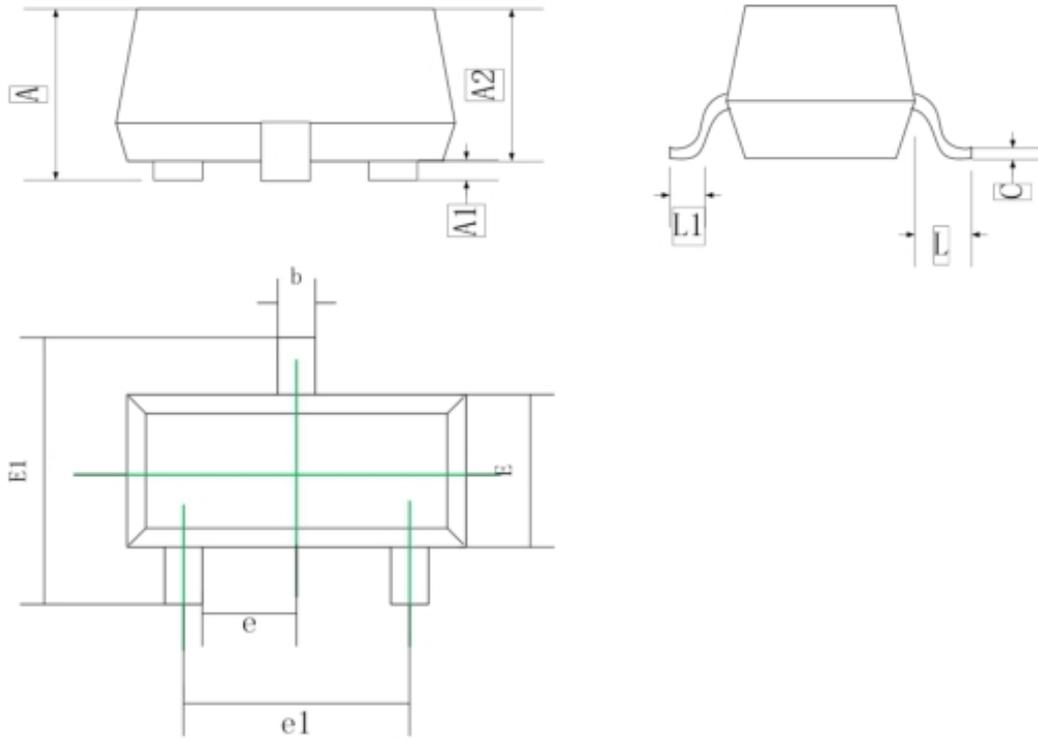


Figure8. Switching wave

SOT-23-3L Package Information



Symbol	Dimensions in millimeters	
	Min.	Max.
A	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.300	0.500
c	0.100	0.200
D	2.820	3.020
E	1.500	1.700
E1	2.650	2.950
e	0.950 Typ.	
e1	1.800	2.000
L	0.300	0.600
θ	0°	8°